

FLEXIBLE METAL FOIL LAMINATE

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Abstract

PROBLEM TO BE SOLVED: To provide a flexible metal foil laminate having a small dimensional stability even by sequentially treating an etching step and a heating step at the laminate obtained by laminating a polyimide and a metal foil.

SOLUTION: The flexible metal foil laminate is obtained by laminating a heat press bondable multilayer polyimide film having a heating shrinkage factor at 300 deg.C of 0.1% or less and the metal foil.

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